

Philips

Diode BYM56A

Datasheet

Silicon Diode

BYM56A

200V/3.5A

DATASHEET

OEM – Philips

Source: Philips Databook 1999

Controlled avalanche rectifiers**BYM56 series****FEATURES**

- Glass passivated
- High maximum operating temperature
- Low leakage current
- Excellent stability
- Guaranteed avalanche energy absorption capability
- Available in ammo-pack
- Also available with preformed leads for easy insertion.

DESCRIPTION

Rugged glass package, using a high temperature alloyed construction.

This package is hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.

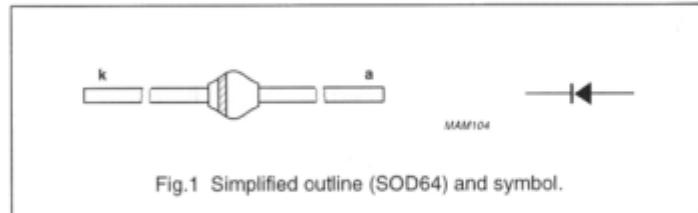


Fig.1 Simplified outline (SOD64) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{RRM}	repetitive peak reverse voltage		–	200	V
	BYM56A			400	V
	BYM56B			600	V
	BYM56C			800	V
	BYM56D			1000	V
V_{RWM}	crest working reverse voltage		–	200	V
	BYM56A			400	V
	BYM56B			600	V
	BYM56C			800	V
	BYM56E			1000	V
V_R	continuous reverse voltage		–	200	V
	BYM56A			400	V
	BYM56B			600	V
	BYM56C			800	V
	BYM56E			1000	V
$I_{F(AV)}$	average forward current	$T_{tp} = 60^\circ\text{C};$ lead length = 10 mm; averaged over any 20 ms period; see Figs 2 and 4	–	3.5	A
		$T_{amb} = 65^\circ\text{C};$ PCB mounting (see Fig.9); averaged over any 20 ms period; see Figs 3 and 4	–	1.4	A
I_{FSM}	non-repetitive peak forward current	$t = 10 \text{ ms half sinewave};$ $T_j = T_{j\max}$ prior to surge; $V_R = V_{RRM\max}$	–	80	A

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SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
E _{RSM}	non-repetitive peak reverse avalanche energy	L = 120 mH; T _j = T _{jmax} prior to surge; inductive load switched off	–	20	mJ
T _{stg}	storage temperature		-65	+175	°C
T _j	junction temperature	see Fig.5	-65	+175	°C

ELECTRICAL CHARACTERISTICS

T_j = 25 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	forward voltage	I _F = 3 A; T _j = T _{jmax} ; see Fig.6	–	–	0.95	V
		I _F = 3 A; see Fig.6	–	–	1.15	V
V _{(BR)R}	reverse avalanche breakdown voltage	I _R = 0.1 mA				
	BYM56A		225	–	–	V
	BYM56B		450	–	–	V
	BYM56C		650	–	–	V
	BYM56D		900	–	–	V
	BYM56E		1100	–	–	V
I _R	reverse current	V _R = V _{RRMmax} ; see Fig.7	–	–	1	µA
		V _R = V _{RRMmax} ; T _j = 165 °C; see Fig.7	–	–	150	µA
t _{rr}	reverse recovery time	when switched from I _F = 0.5 A to I _R = 1 A; measured at I _R = 0.25 A; see Fig.10	–	3	–	µs
C _d	diode capacitance	V _R = 0 V; f = 1 MHz; see Fig.8	–	90	–	pF

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th,j-tp}	thermal resistance from junction to tie-point	lead length = 10 mm	25	K/W
R _{th,j-a}	thermal resistance from junction to ambient	note 1	75	K/W

Note

- Device mounted on epoxy-glass printed-circuit board, 1.5 mm thick; thickness of copper ≥ 40 µm, see Fig.9.
For more information please refer to the "General Part of Handbook SC01".

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GRAPHICAL DATA

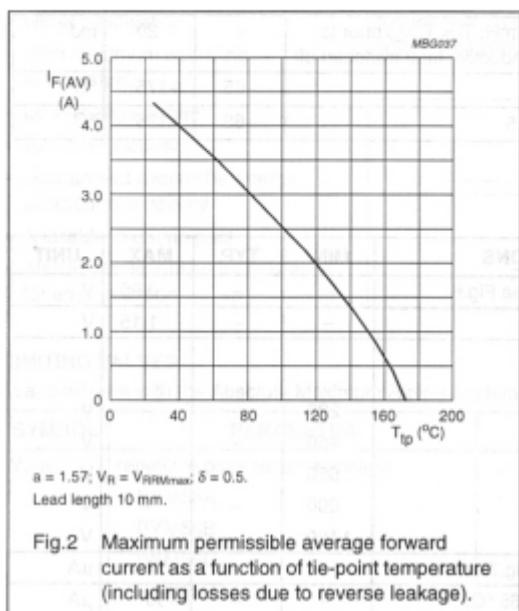


Fig.2 Maximum permissible average forward current as a function of tie-point temperature (including losses due to reverse leakage).

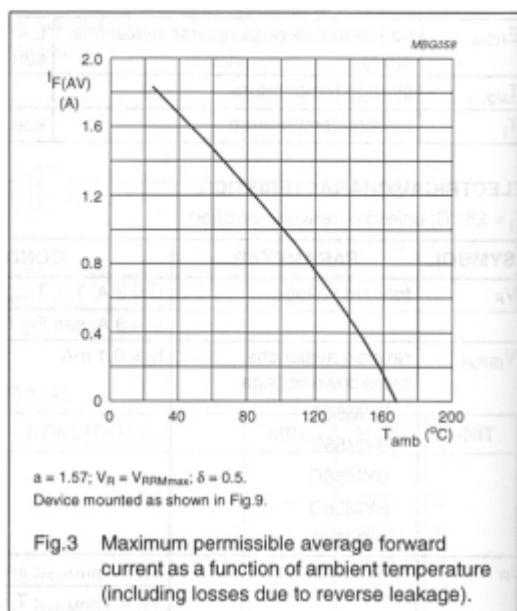


Fig.3 Maximum permissible average forward current as a function of ambient temperature (including losses due to reverse leakage).

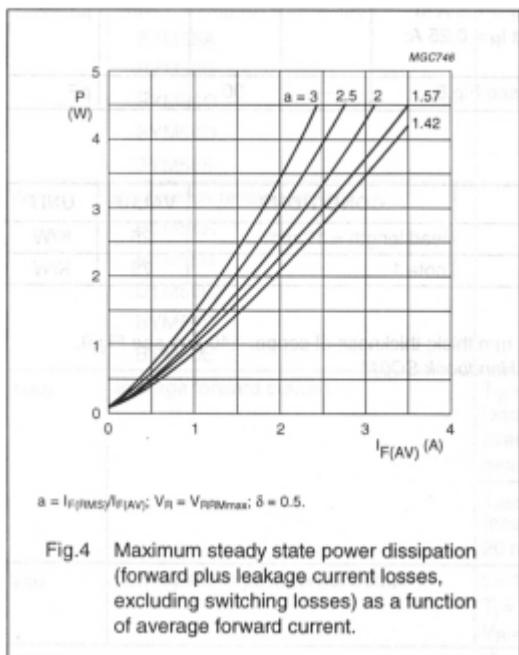


Fig.4 Maximum steady state power dissipation (forward plus leakage current losses, excluding switching losses) as a function of average forward current.

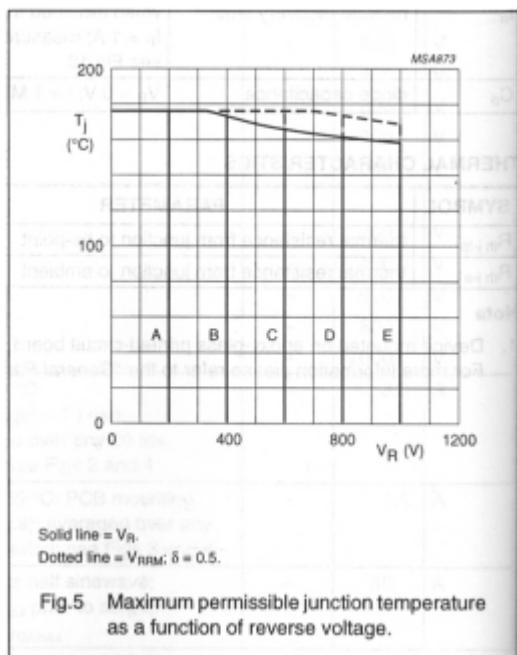
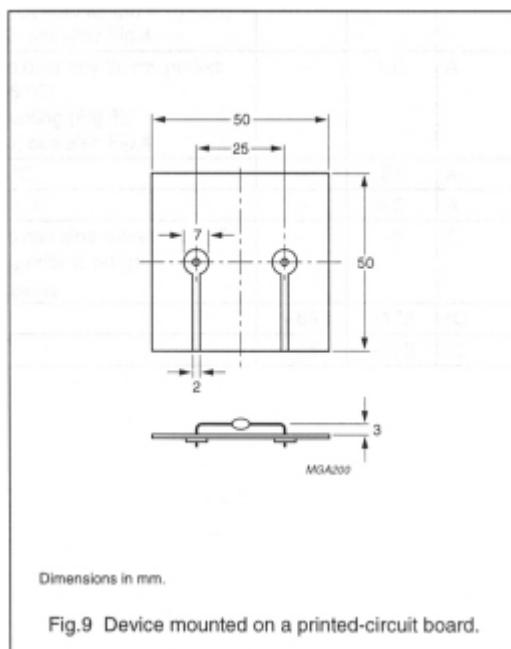
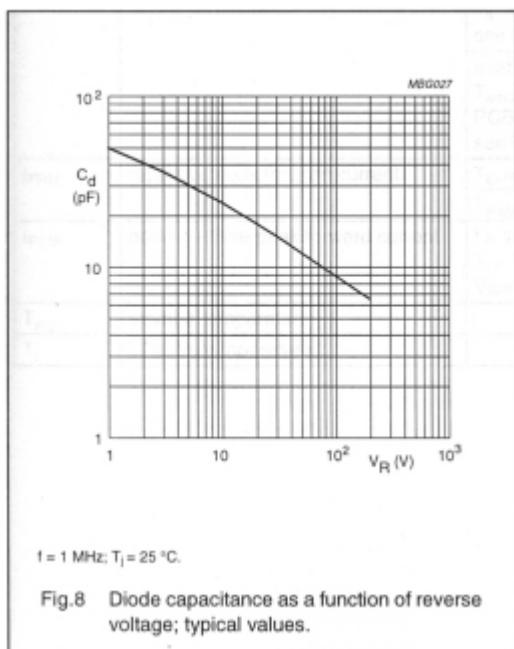
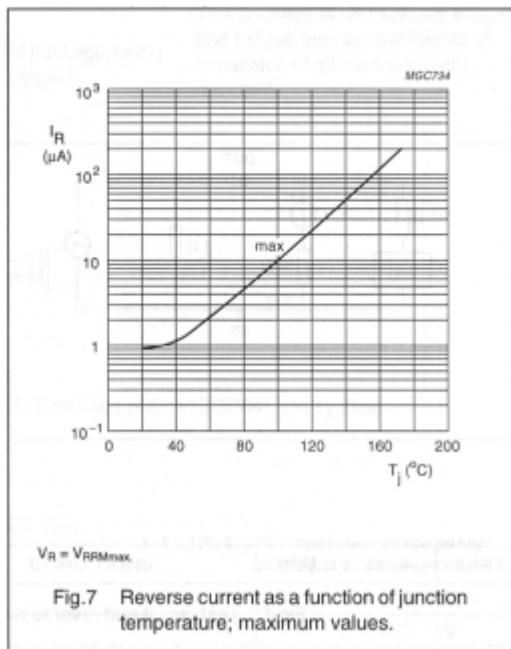
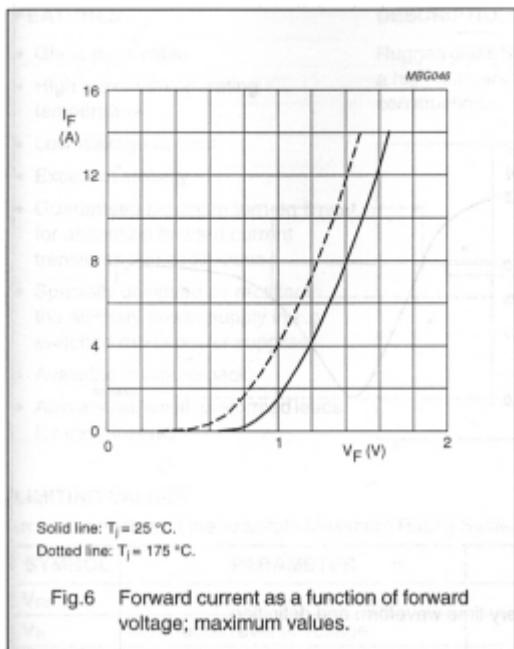


Fig.5 Maximum permissible junction temperature as a function of reverse voltage.

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